

Vincent Lagardelle SPM Business Development

October 2019 | Session T3697









SECURE CONNECTIONS FOR A SMARTER WORLD

Autonomy



Electrification



Connectivity



Safe and Secure Mobility



Autonomy



AMF-AUT-T3628 Safety Power Management for Automotive Radar and ADAS Applications

Yasuomy Sakyu Tuesday 4:00 PM Samuel (Lower Level)

Electrification



AMF-AUT-T3832 Electrification—Functional Safety Backbone Solutions to Attach with S32

Tuesday 11:00 AM Galilee (Main Floor)

Connectivity



AMF-AUT-T3833
Power Management for Connectivity
and Infotainment Solutions

Wednesday 9:10 AM Kings I & II (Lower Level)

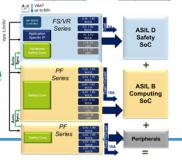
Vincent Lagardelle

AMF-AUT-T3697
PF81/PF82 PMICs for HighPerformance Applications Processors

Wednesday 1:30 PM Samuel (Lower Level)

Safety PMIC Demo

Visit us at the TechLab



One System = Multi
PMIC Solution



JP Meunier

AMF-AUT-T3832
Functional Safety in Power
Management (Safety PMICs) and
System Considerations

Wednesday 10:00 AM Judith (Upper Level)



Vincent Lagardelle

AMF-AUT-T3631 Scalable & Safe Power Management Solutions Overview

Tuesday 10:00 AM



Jeff Reiter

AMF-AUT-T3884 SPM Tool Overview

Wednesday 4:00 PM Sarah (Upper Level)



AGENDA

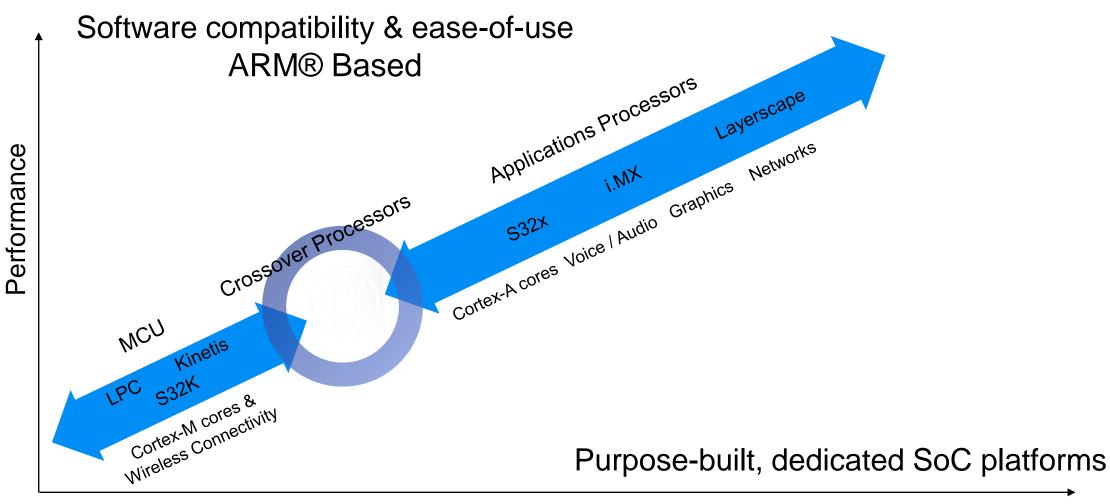
- Portfolio overview
- Solutions for S32
- Solutions for iMX8
- Solutions for Layerscape
- Tools Overview







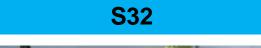
NXP Scalable Processing Continuum



Functional Integration



Safety PMIC Overview





MC33907/8 FS6500,FS8500,PF8200

i.MX



PF0100, PF3000 PF8200

Layerscape

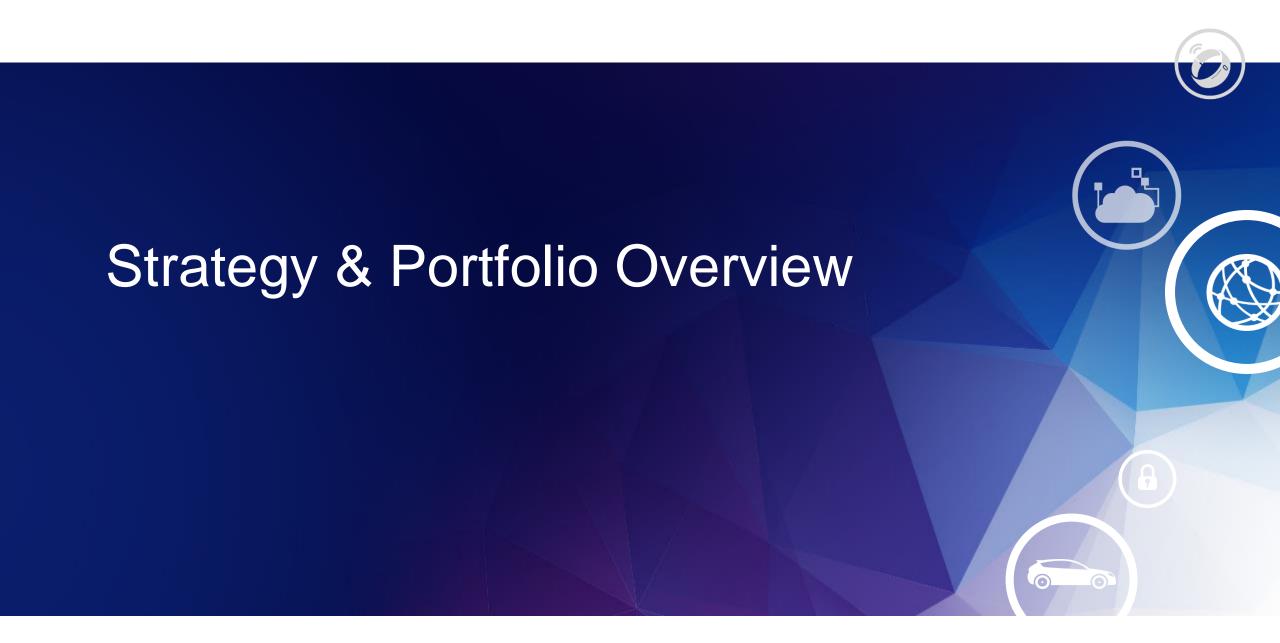


VR500, PF8200

BENEFITS:

- Support MCU's power and safety scalability platform requirement
- Co-developed and validated with the MCU for an optimized solution

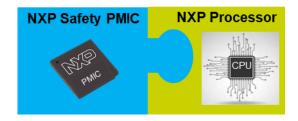






Automotive Safety Power Management Solutions Strategy

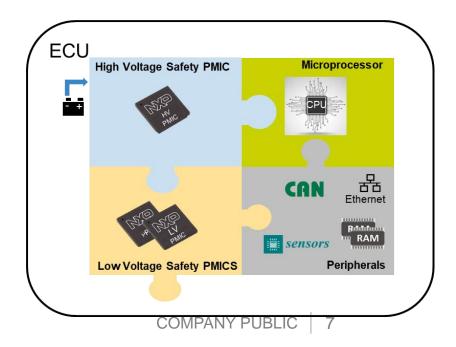
1 100% Processor Attach



2 System Power Solutions

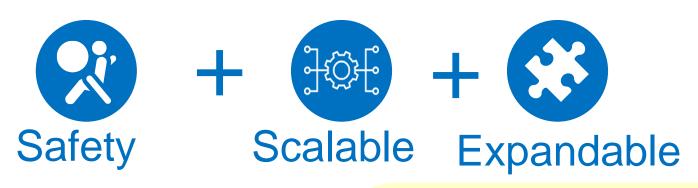


SAFETY PMIC "building blocks" Portfolio

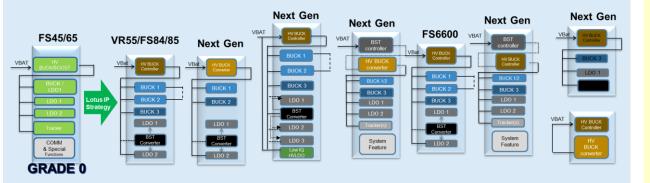




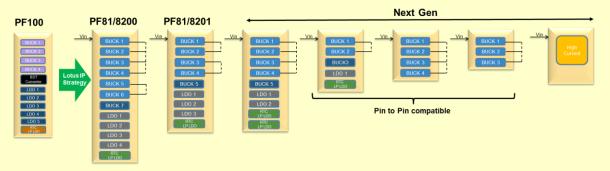
NXP Safety PMIC's DNA



Automotive PMIC 12V/24V Battery Connected



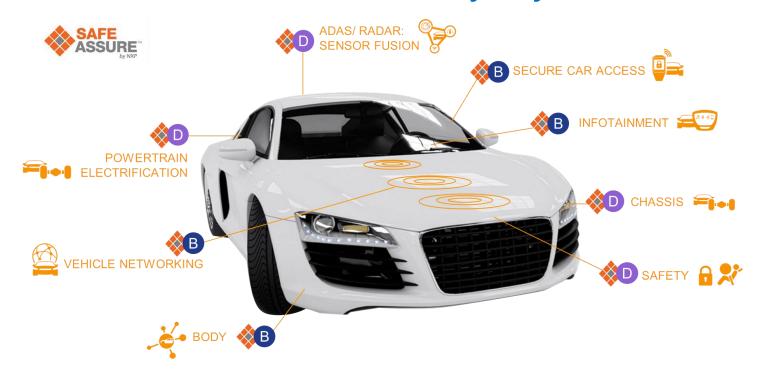
Automotive PMIC <5V Low Vin Connected







NXP Functional Safety System Solutions



Dedicated session

AMF-AUT-T3832

Functional Safety in Power
Management (Safety PMICs) and
System Considerations

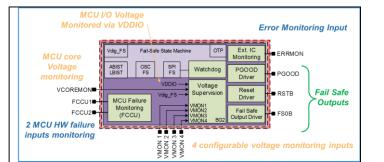
Wednesday 10:00 AM Judith (Upper Level)

3rd Generation of SAFETY PMICs

PROCESS



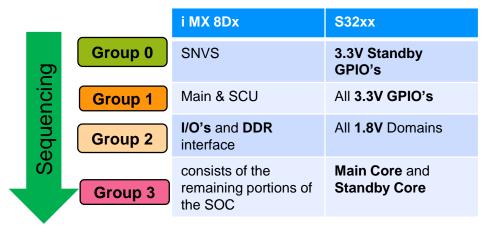
SAFETY ARCHITECTURE

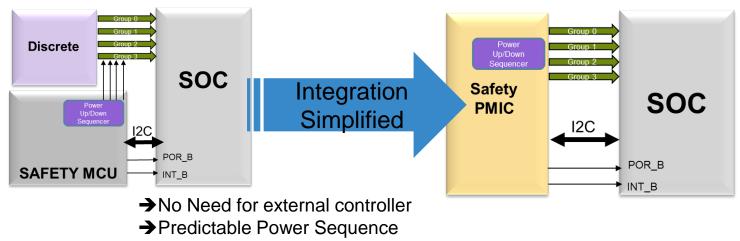






- Flexible product through OTP configuration
 - ✓ Buck / LDO/ Boost value setting
 - ✓ Embedded & configurable Power up /down sequencer



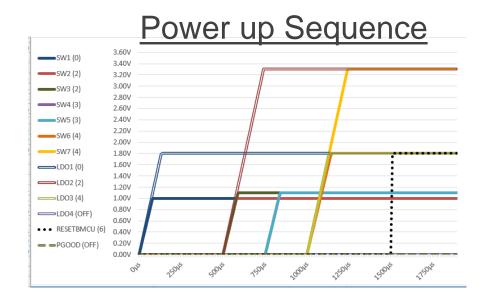


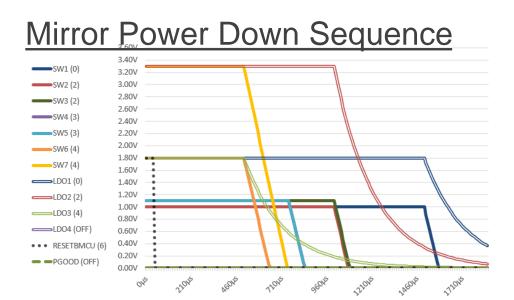
- ✓ Safety reaction
- ✓ Some functionality



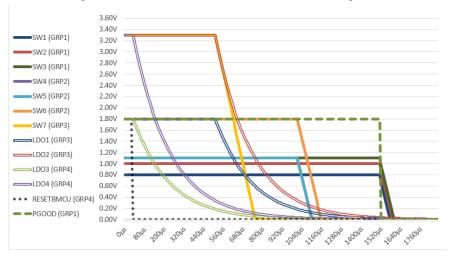


Configurable & Predictable Power Sequence via OTP Bits





Group Power Down Sequence





OTP configuration list example

PF8100	PF8200	Customer	Target	
A0	A0	General	Non-OTP part	
CC		General	i.MX8QXP MEK with LPDDR4	
CD		General	i.MX8QM MEK with LPDDR4, PMIC1 with VDD_MIAN	
CE		General	i.MX8QM MEK with LPDDR4, PMIC2 with VDD_GPU	
CF		General	i.MX8QXP with DDR3L	
CG		General	i.MX8QM with DDR4, PMIC1 with VDD_MIAN	
CH		General	i.MX8QM with DDR4, PMIC2 with VDD_GPU	
	CX	General	LS1043A	
	D2	General	S32V2 reference board	
	DA	General	i.MX8QM with LPDDR4, PMIC1 with VDD_MIAN	
	DB	General	i.MX8QM with LPDDR4, PMIC2 with VDD_GPU	
	DE	General	i.MX8QXP with LPDDR4	
	DF General i.MX8QXP with DDR3L		i.MX8QXP with DDR3L	
	DG General i.MX8QM with DDR4, PMIC1 with VDD_MIAN		i.MX8QM with DDR4, PMIC1 with VDD_MIAN	
	DH	General	i.MX8QM with DDR4, PMIC2 with VDD_GPU	
	DM	General	S32V reference board	
	DN	General	S32R reference board	



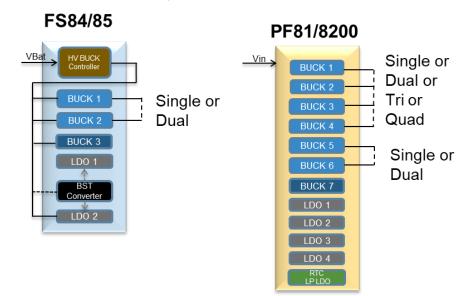


Scalable product:

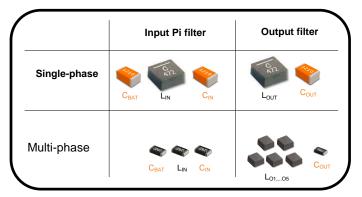
- ✓ Safety scalability
- ✓ Portfolio scalability



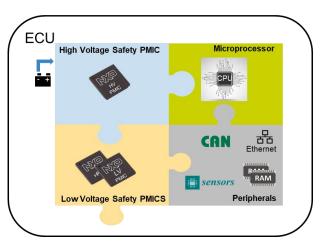
Power scalability: 2 to 4 Buck in multiphase



Board Performance & Size







ONE SYSTEM = MULTI PMIC SOLUTION

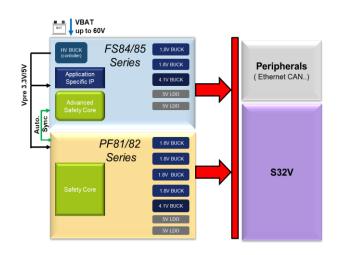




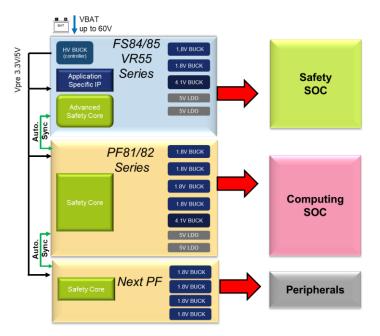




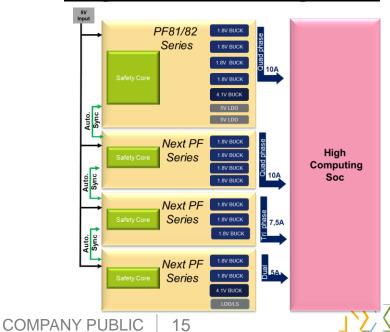
Global System Solution



Multi Processor System



High Computing Soc



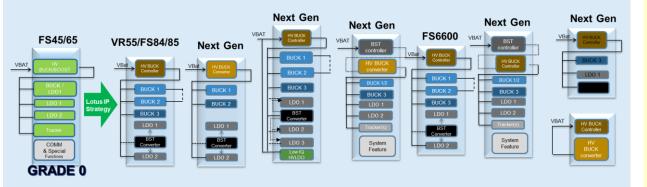




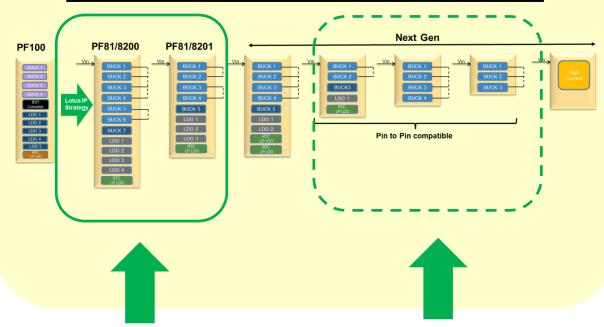
NXP Safety PMIC's DNA



Automotive PMIC 12V/24V Battery Connected



Automotive PMIC <5V Low Vin Connected





Automotive Low Vin PMIC

PF81/82x Automotive High Integration 5.5V PMIC

Differentiating Points

- High Power, High Efficiency up to 10 A Core supply and > 19A total output power with tight accuracy and advanced thermal management
- Proven & Robust solution co-developed with MCU. BSP and reference designs provided.
- Scalable supply for MCU family with OTP configurability options
- Minimize EMC with Spread spectrum, frequency tuning, frequency synchronization and multi-phase operation
- Optimized Size through advanced architecture, < 200mm2 component area
- Fit for for **ASIL-B** Application (PF8200)

Product Features

- Vin 2.7 5.5 V
- 6 Buck 0.4- 1.8 V, 2.5A Master/Slave;1 Buck 1.2- 4.5V Independent
- 4 LDO 1.5 5 V
- -40°C to 105°C Operating Ambient Temperature (150°C Tj)
- Prog Freq, Dynamic Freq Spread Spectrum, Ext Clock Synch
- 32 Channel AMUX, OV,UV
- Qualified for QM level (PF8100) or ASIL-B Safety Level (PF8200)
- 8x8mm 56-LD QFN-EP
- Automotive and Industrial grades available

Applications

- Infotainment / Cluster
- Driver Awareness
- Vision
- Cable/Internet Stream Boxes
- Industrial/Consumer



PF8200 Functional Block Diagram

Logic & Control

I2C

Watchdog

MCU Interface

Regulator Control Fault Detection

Functional Safety

(ABIST)

LDO1

(1.5V to 5V, 400mA)

LDO2

(1.5V to 5V, 400mA)

LDO3

(1.5V to 5V, 400mA)

LDO4

(1.5V to 5V, 400mA)

VSNVS (RTC Supply) (1.8V/3.0V/3.3V, 10mA)

32 Channel AMUX (Diagnostics)

OTP (Flexible Configuration)

BUCK2 (Master/Slave)

BUCK1 (Master/Slave)

(0.4V to 1.8V, 2.5A)

(0.4V to 1.8V, 2.5A)

BUCK3 (Master/Slave) (0.4V to 1.8V, 2.5A)

BUCK4 (Master/Slave) (0.4V to 1.8V, 2.5A)

BUCK5 (Master/Slave) (0.4V to 1.8V, 2.5A)

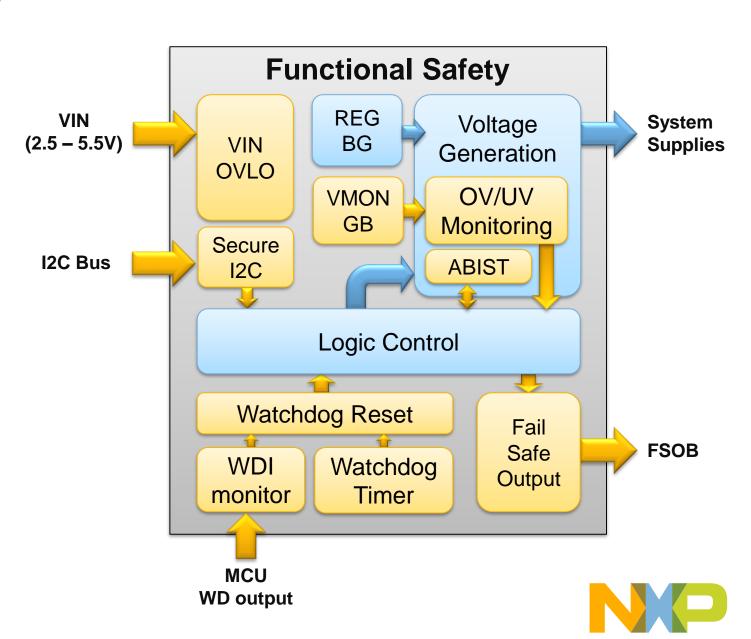
BUCK6 (Master/Slave) (VTT/0.4V to 1.8V, 2.5A)

BUCK7 (Independent) (1.0V to 4.1V, 2.5A)



PF8200 – Functional Safety

- Input Overvoltage Lockout
- Regulator Output Monitoring
 - Programmable OV/UV monitoring
 - Independent Bandgap
- Analog built in Self-test
 - ABIST on Output monitoring Blocks
- Watchdog Reset
 - WDI monitoring
 - Internal WD Timer
- Secure I2C Communication
 - CRC verification
 - I2C Secure Write
- Programmable Safety Output





System Safety Integration

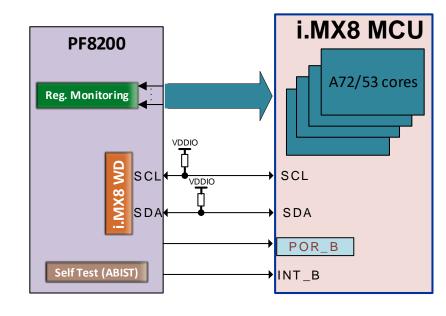
i.MX 6 solution

PF0100 Regulators A9 cores POR_B INT_B Power PC Safety MCU POR_B INT_B PMIC + i.MX 6 monitoring

Integration Simplified

- PCB layout and integration highly simplified
- No need of external MCU to endorse the safety of the system
- System BOM reduced
- Higher latent failure coverage on PMIC thanks to the ABIST

i.MX 8 + PF82 solution



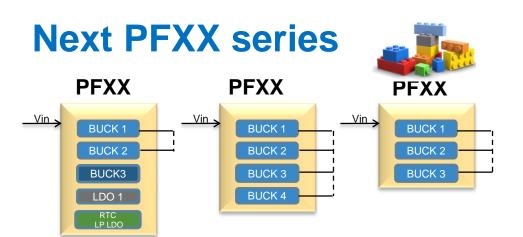




Scalability

Function	PF8100	PF8200
Buck regulator w/ DVS	6ch	6ch
Buck regulator w/o DVS	1ch	1ch
LDO	4ch	4ch
VSNVS regulator	1ch	1ch
AMUX output	1ch	1ch
Communication I/F	I2C with CRC	I2C with CRC
Watchdog	Yes	Yes
	PWRON, STANDBY, INTB,	PWRON, STANDBY, INTB,
	RESETBMCU, EWARNB,	RESETBMCU, EWARNB,
MCU I/F	PGOOD, WDI	PGOOD, WDI
OV/UV monitoring	Yes	Yes
OTP program	Yes	Yes
ABIST	No	Yes
20MHz CLK check	No	Yes
OTP CRC check	No	Yes
Fail-Safe state	No	Yes
Sequire I2C write protection	No	Yes
Target ASIL class	Non-ASIL or QM	ASIL-A or B
Package	56-QFN w/ WF	56-QFN w/ WF





Product Features

- Up to 10A Core/GPU supply and advanced thermal management
- Reduced noise: Spread spectrum, manual frequency tuning, frequency synchronization and dual-phase operation
- Reduced solution size through internal compensation, Total Component size of < 100mm2
- > Fit for ASIL-B
- OTP configurability for scalable/flexible solutions
- > -40°C to 125°C Operating Ambient Temperature
- 6mmx6mm 40LD QFN-EP Package
- Automotive and Industrial grades available



- > Safety Feature available:
 - > WD
 - Diagnosis feature : UV/OV, CRC.....
- Higher latent failure coverage compared to discrete thanks to ABIST
- > Scalability:
 - Embedded power up sequencer
 - Hardware Control as well as I2C control
 - Multiphase operation

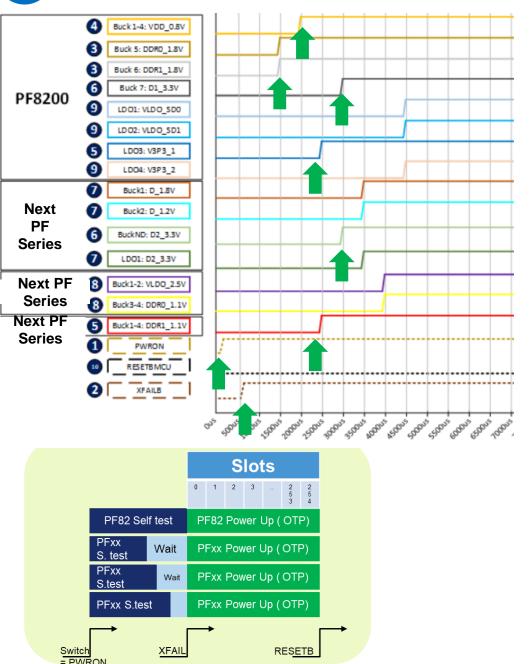
- > Expandable
 - "LEGO BLOCK" Approach
 - Expandable solution
 - Several PMIC acting like one PMIC
 - no need for external MCU
 - Advanced Thermal Management Approac
 - One common SW family based on I2C

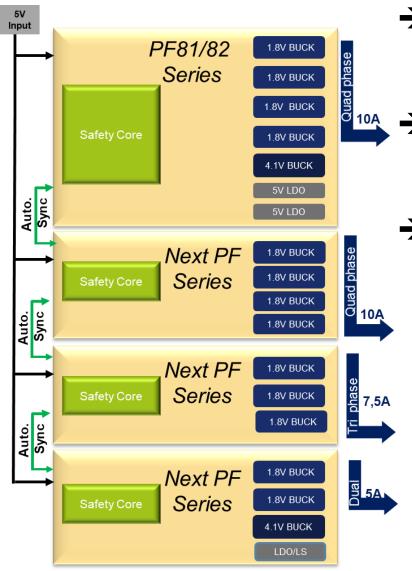


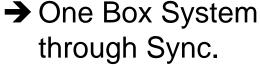


**

Multiple PF DEVICE: "Smart Companion" configuration



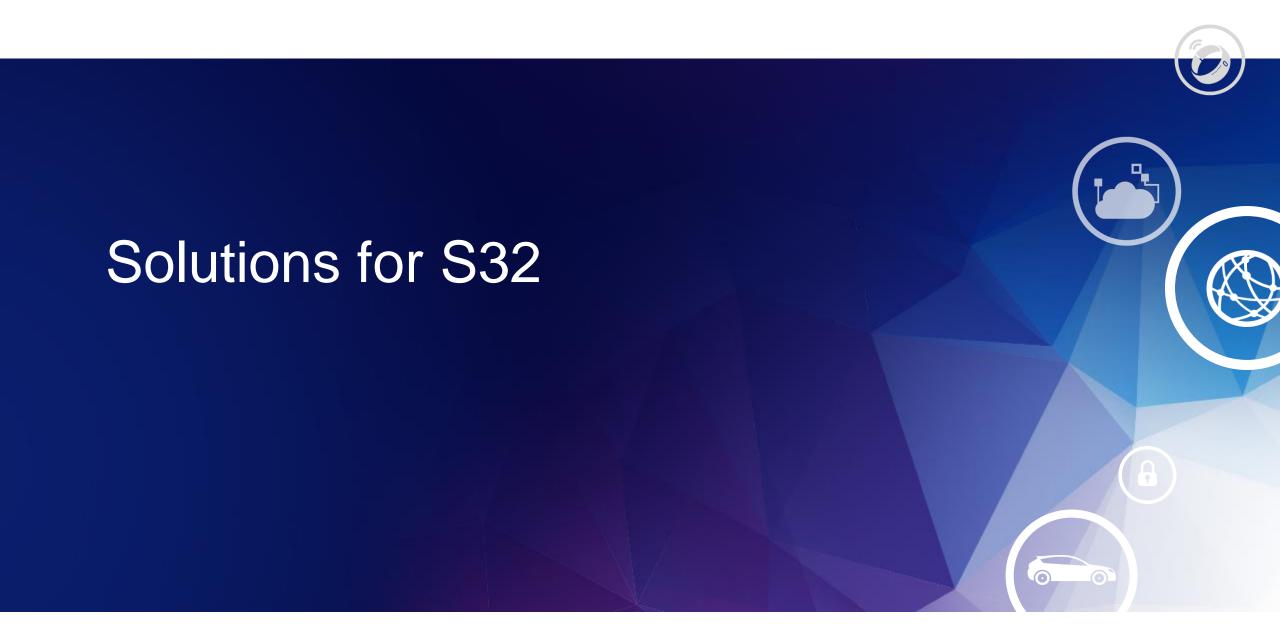




- → Better Thermal Approach
- → Ensure Signal integrity



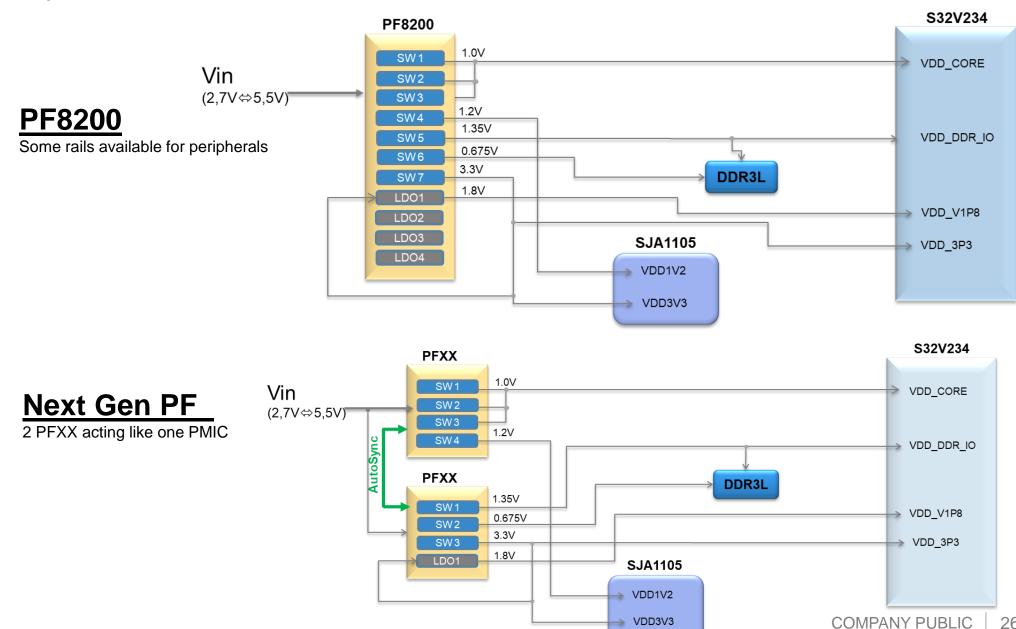






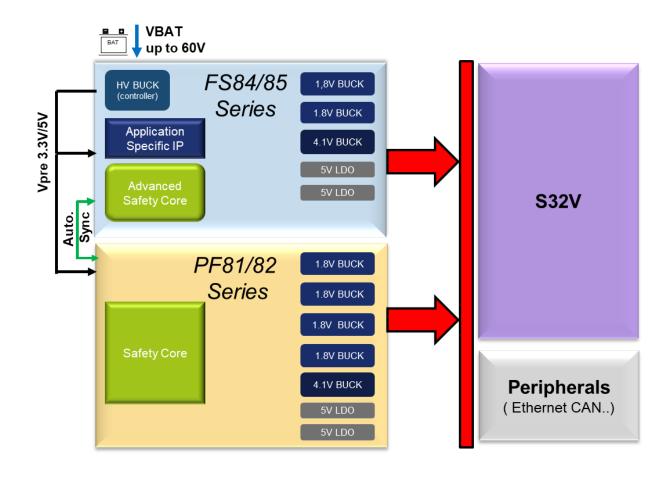


System Solution for S32V + Ethernet





System Solution for S32V + Ethernet FROM VBAT



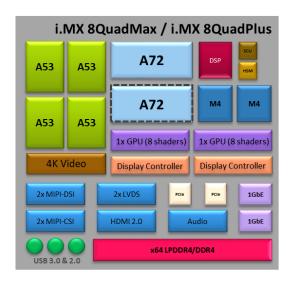


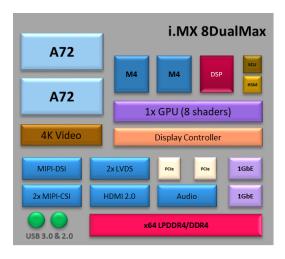


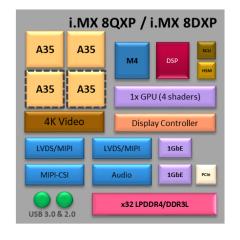


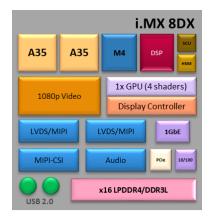
i.MX 8 & 8X Subsystem Reuse

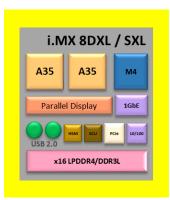
Maximize Scalability of Embedded Processing to Reduce Design Complexity











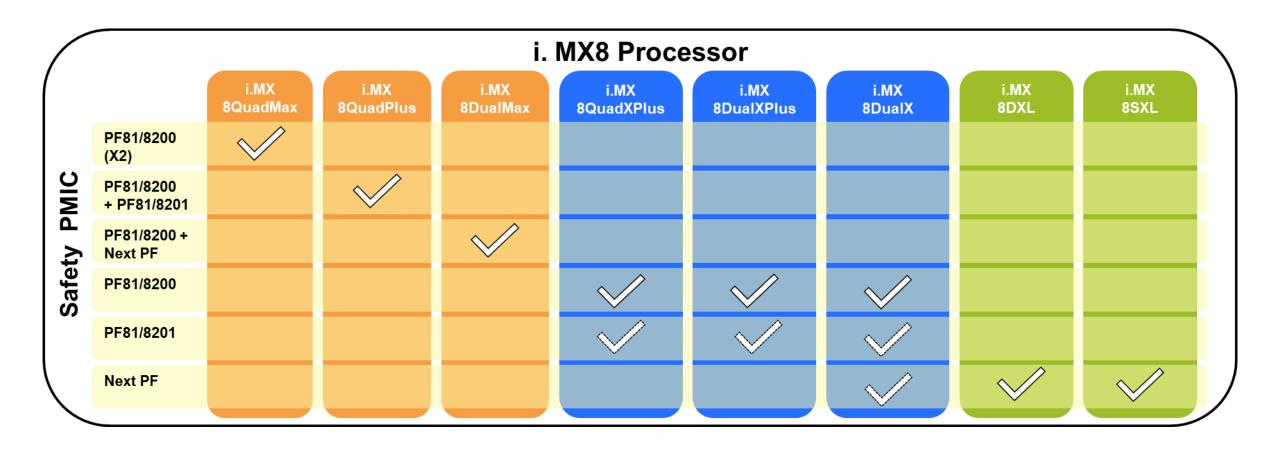
Auto HMI, Vision, Audio and Voice Enabled with i.MX

DSP, Vision Acceleration, Real Time Domain, Safe Camera/Display/Audio, Simplified eCockpit

New Telematics / V2X / Smart Antenna Optimization i.MX 8DXL / i.MX 8SXL

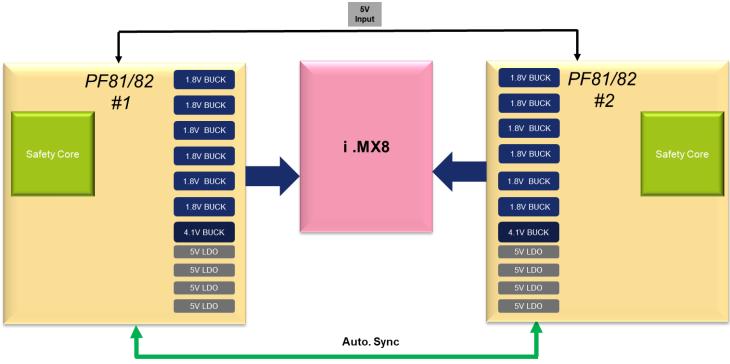


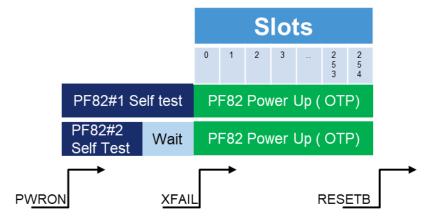








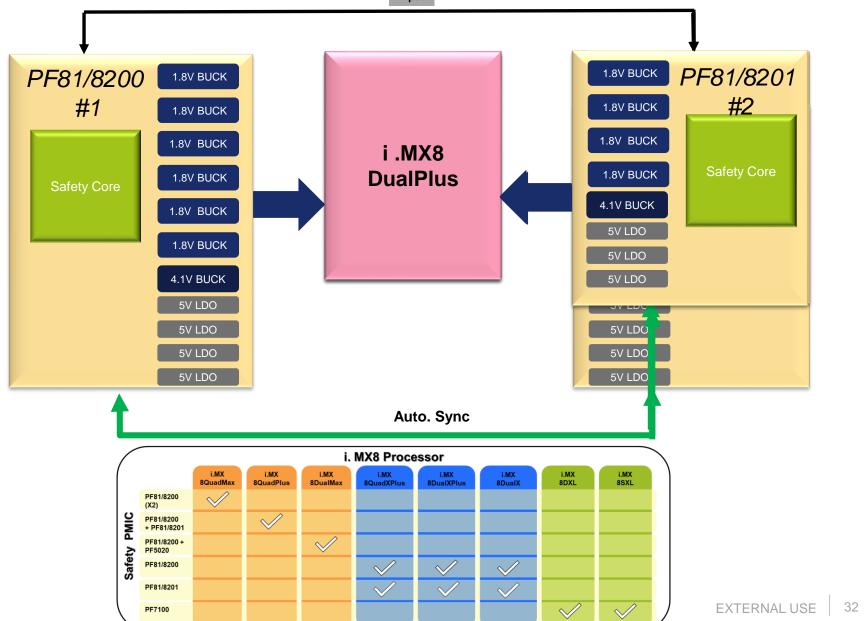














i. MX8QuadMax / QuadPlus / DualMax

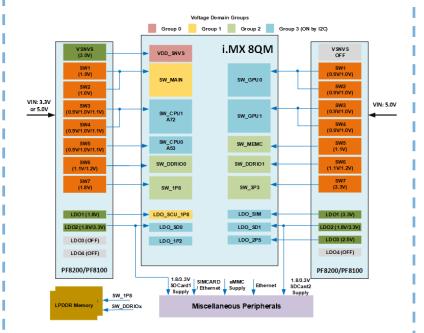
Compatible Design

i.MX8QuadMax i.MX8QuadPlus



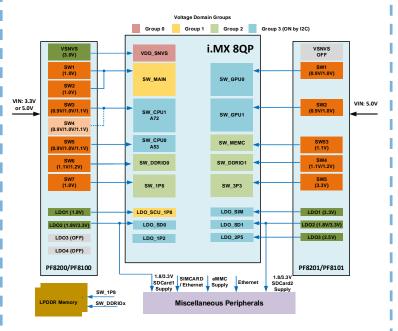
i.MX8DualMax

2 x PF8100/8200



Optimized i.MX8QuadPlus

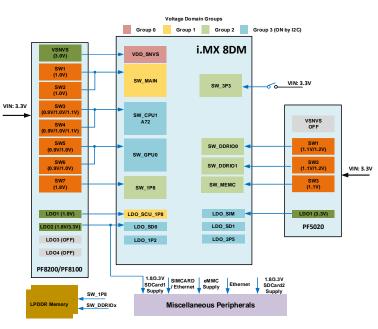
PF81/8200 + PF81/8201 (or Next PF)



Optimized

I. MX8DualMax

PF81/8200 + Next PF





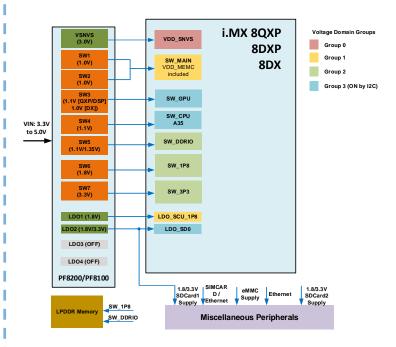
i. MX8QuadXPlus / DualXPlus / DualX

Compatible Design i.MX 8QuadXPlus

i.MX 8DualXPlus

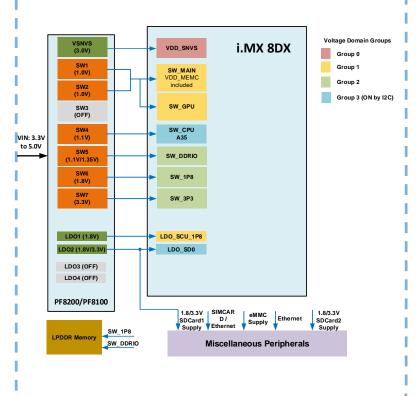
i.MX 8DualX

PF8100/8200

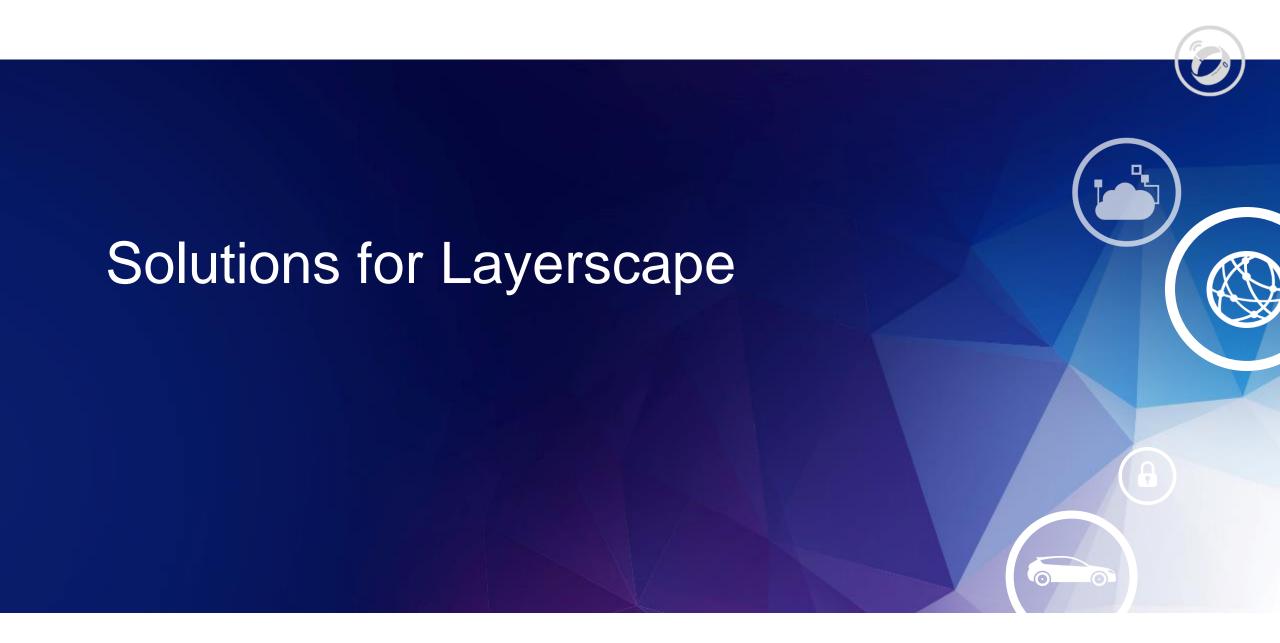


Optimized i.MX 8DualX

PF81/8200

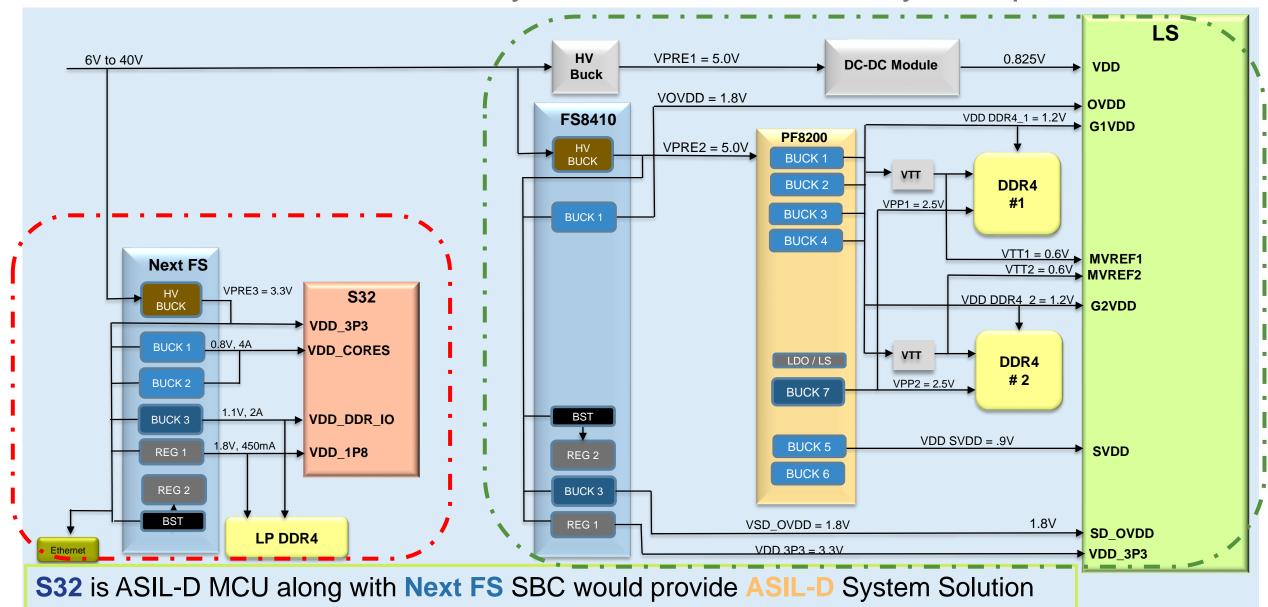




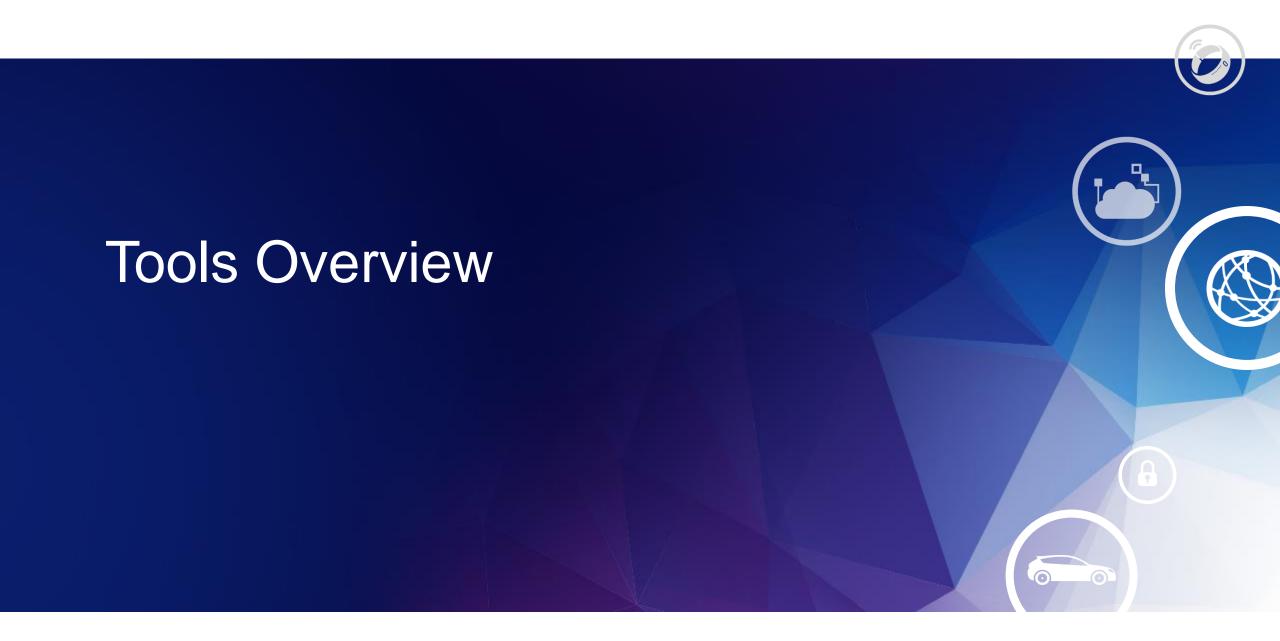




NXP Power Solution of Safety ADAS Module with Layerscape



N





Customer Support



- Device documentation
- Safety Documentation
- PCB Schematic & guidelines



- Thermal Tool
- OTP Programming Tool
- EVB Boards



External Sharepoint for customer

PF81/82 – Documentation & Application Support





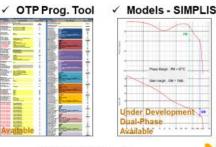












COMPANY PUBLIC | 66



PF81/82 Customer Boards





Description / Purpose:

OTP Programming

Soldered

KITPF8200FRDMEVM EVALUATION BOARD

Available

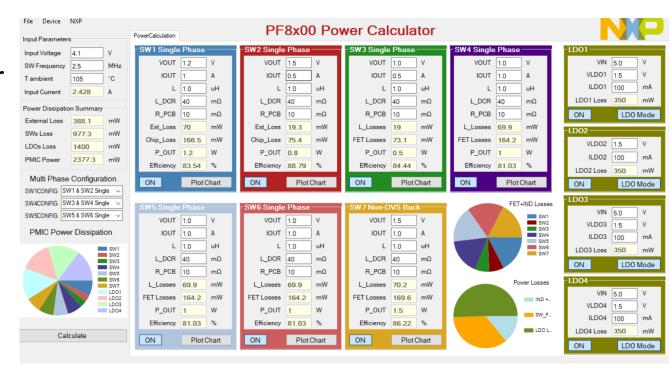


Description / Purpose:

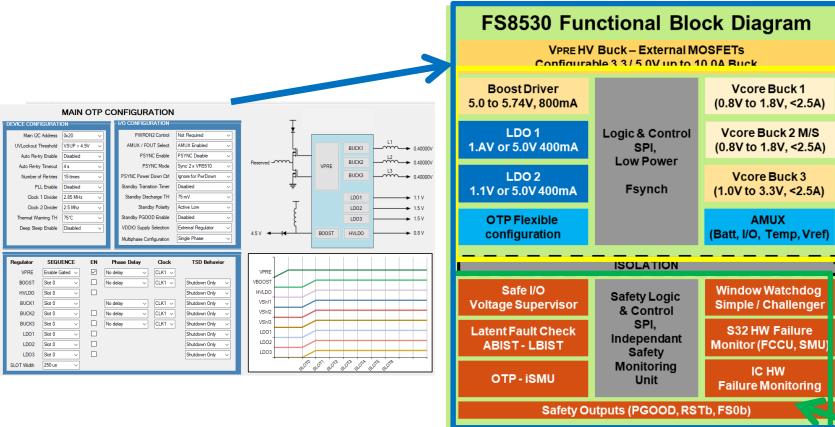
- Performance Validation
- OTP Programming (Populated part)
- · Highly flexible

Thermal Tool

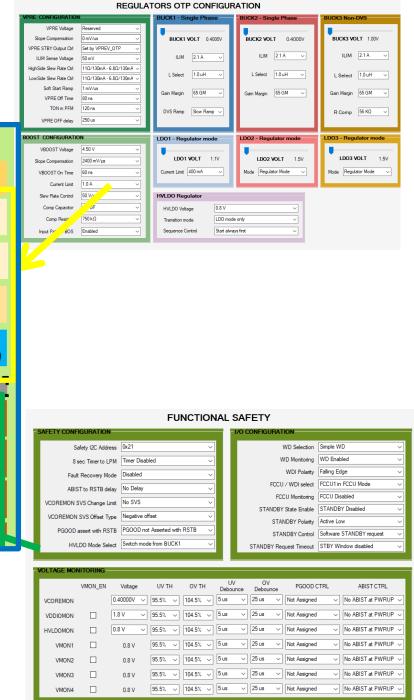
- Thermal tool available to assess IC power dissipation and external component power losses.
- Modeling validated with lab measurement
- Easy to use tool:
 - External component configurable
 - Multiphase mode

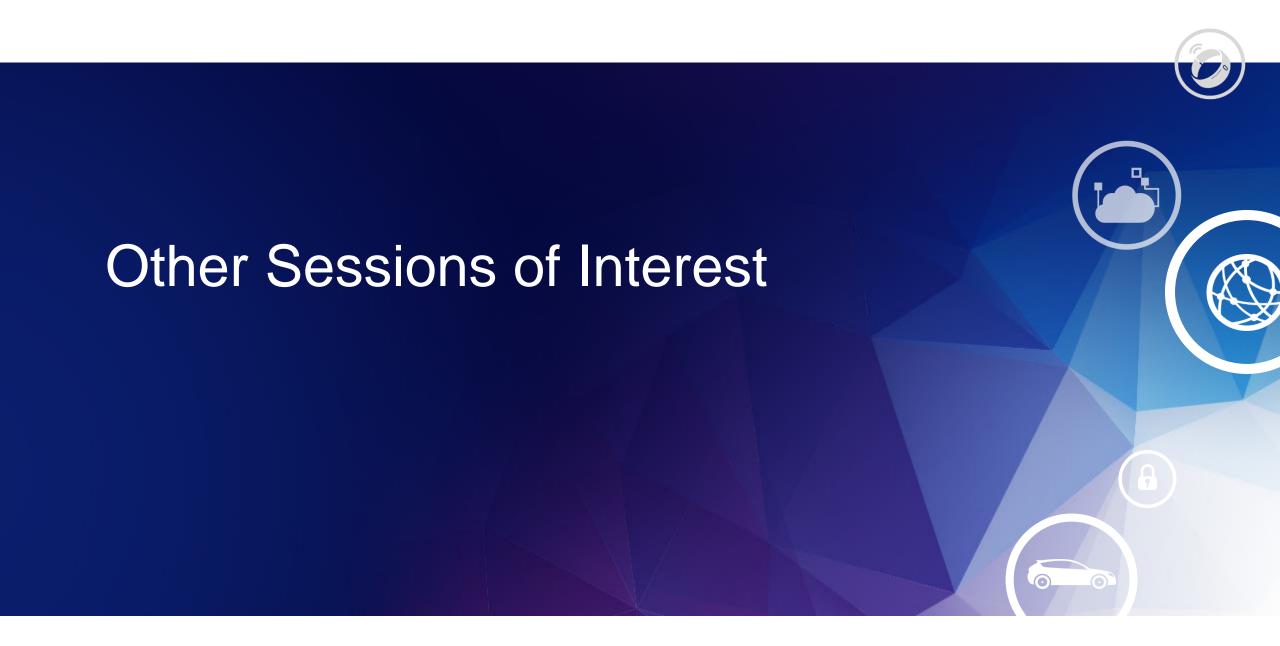


OTP Tool



- OTP tool available to configure device during debug phase
- Easy to use tool







Autonomy



Automotiv Application

Yasuomy Sakyu

AMF-AUT-T3628 Safety Power Management for Automotive Radar and ADAS Applications

Tuesday 4:00 PM Samuel (Lower Level)

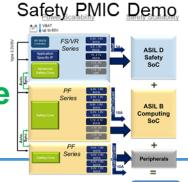
Electrification



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Tuesday 11:00 AM Galilee (Main Floor)

Visit us at the TechLab



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PMIC Solution

Connectivity



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Power Management for Connectivity
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NXP SAFETY PMIC DNA



NXP PMIC's: Your Functional Safety Partner

Delivering safety and power scalable solutions to enable a platform strategy



SECURE CONNECTIONS FOR A SMARTER WORLD